

ATTY DKT. No.: AMAT/7669.P2/CMP/ECP/RKK
U.S. SERIAL No.: UNKNOWN CONF. NO.: UNKNOWN
FILED: HEREWITH
APPLICANT: APPLIED MATERIALS
TITLE: ANOLYTE FOR COPPER PLATING
INVENTOR: MICHAEL X. YANG, ET AL.
EXPRESS MAIL No.: EV 351031288US PAGE 1 OF 5

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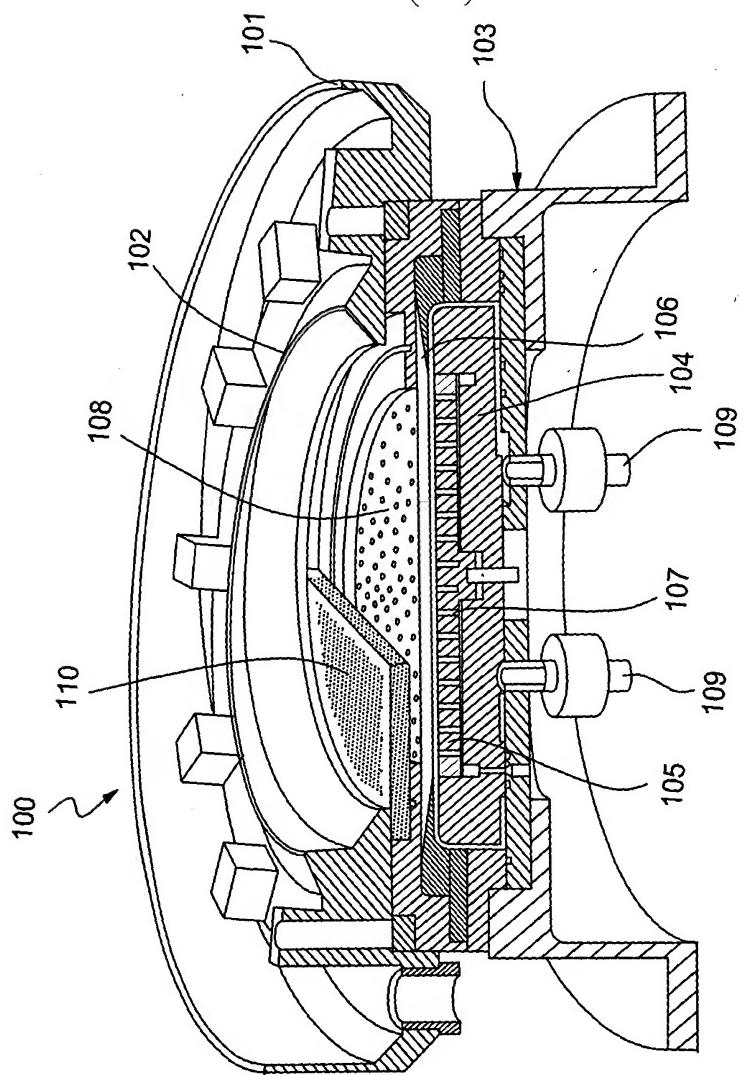


FIG. 1

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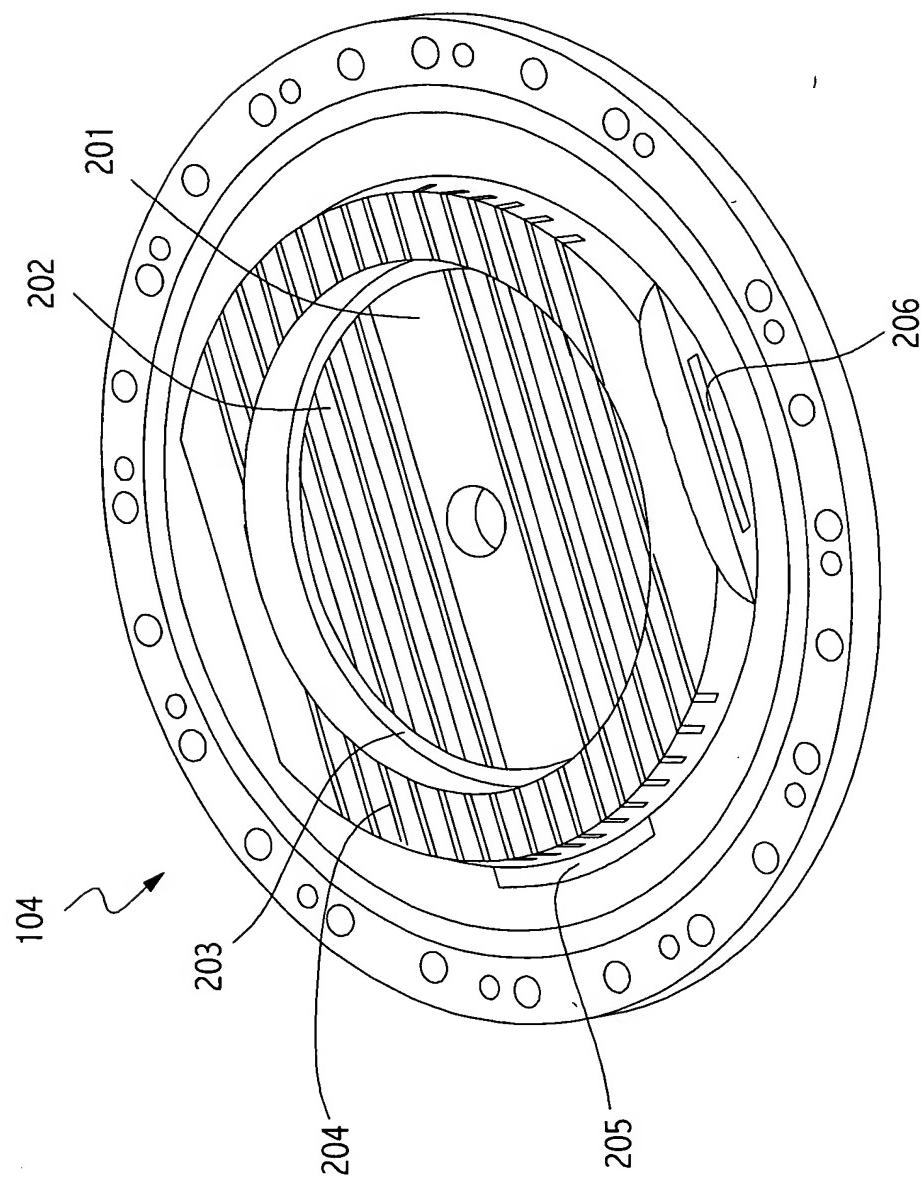


FIG. 2

ATTY DKT. No.: AMAT/7669.P2/CMP/ECP/RKK
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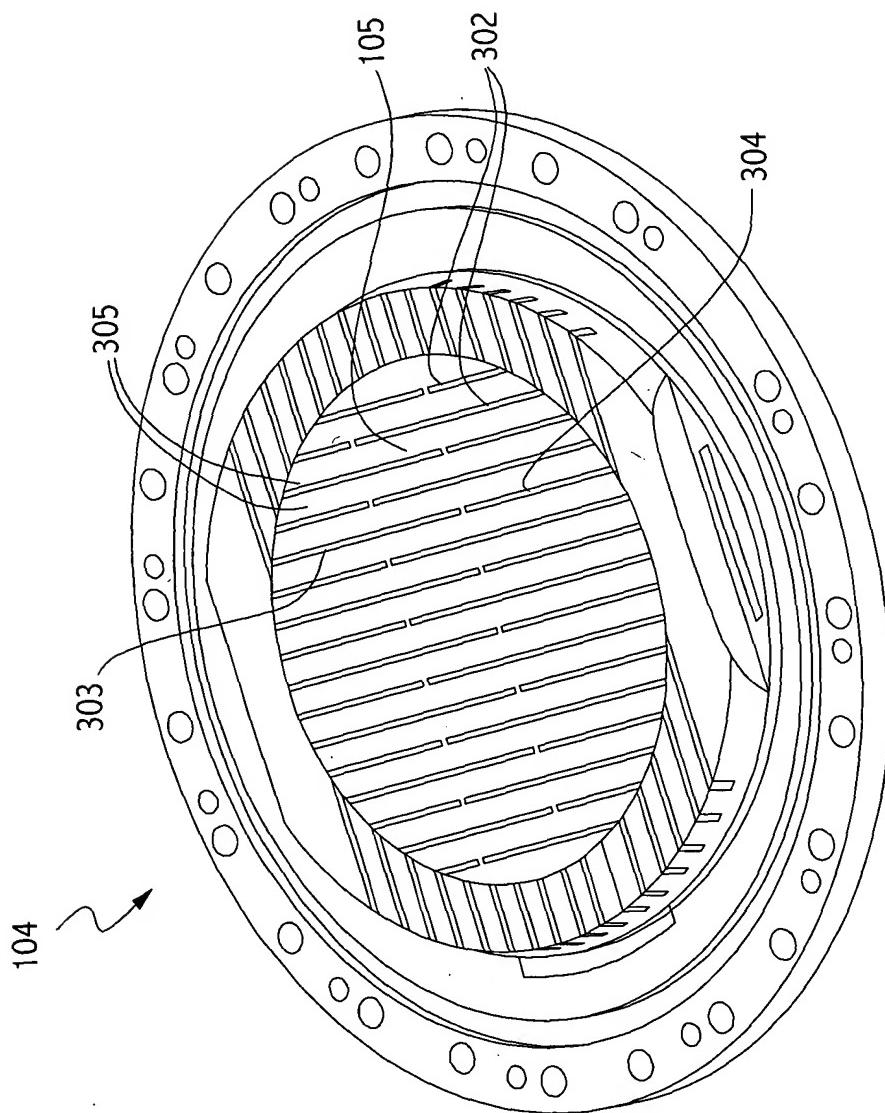


FIG. 3

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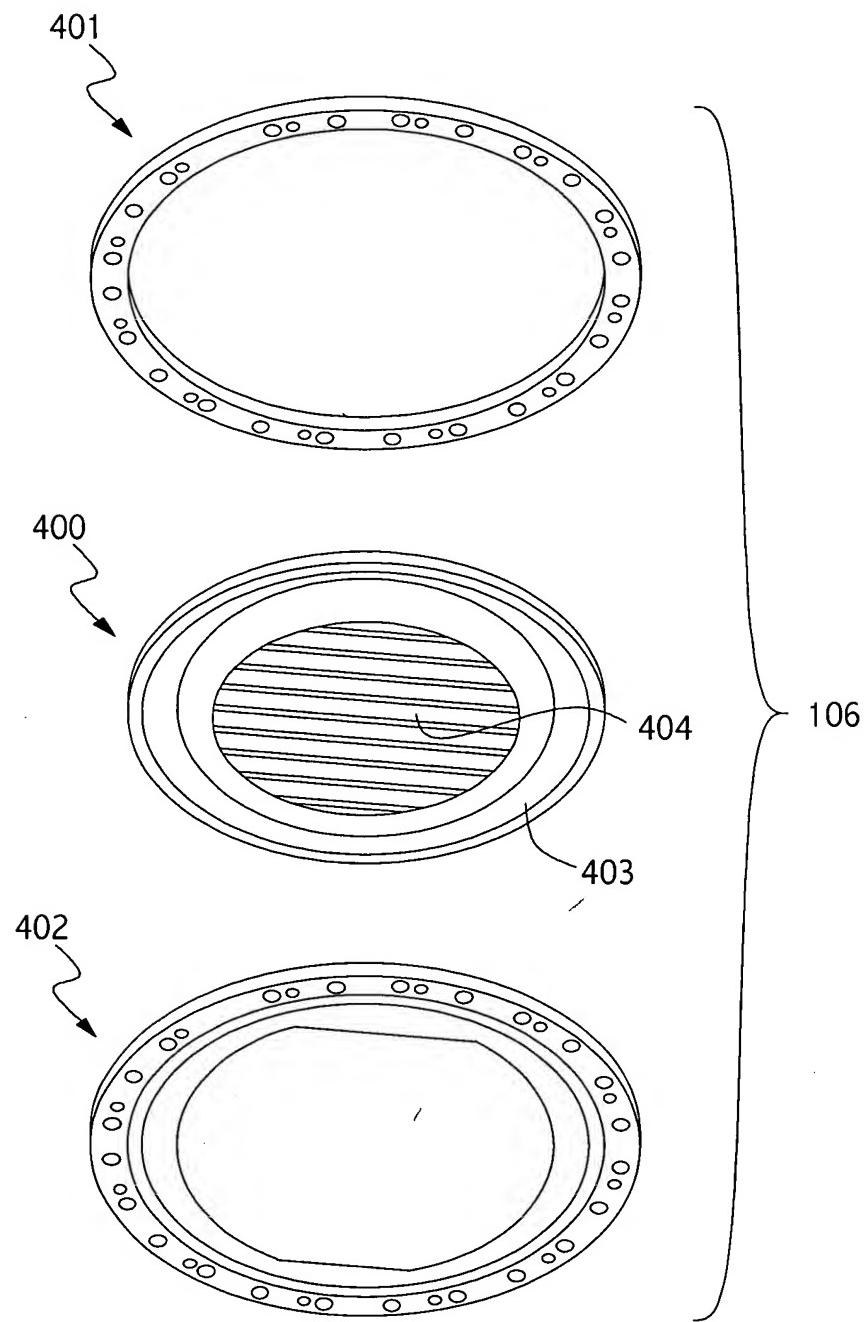


FIG. 4

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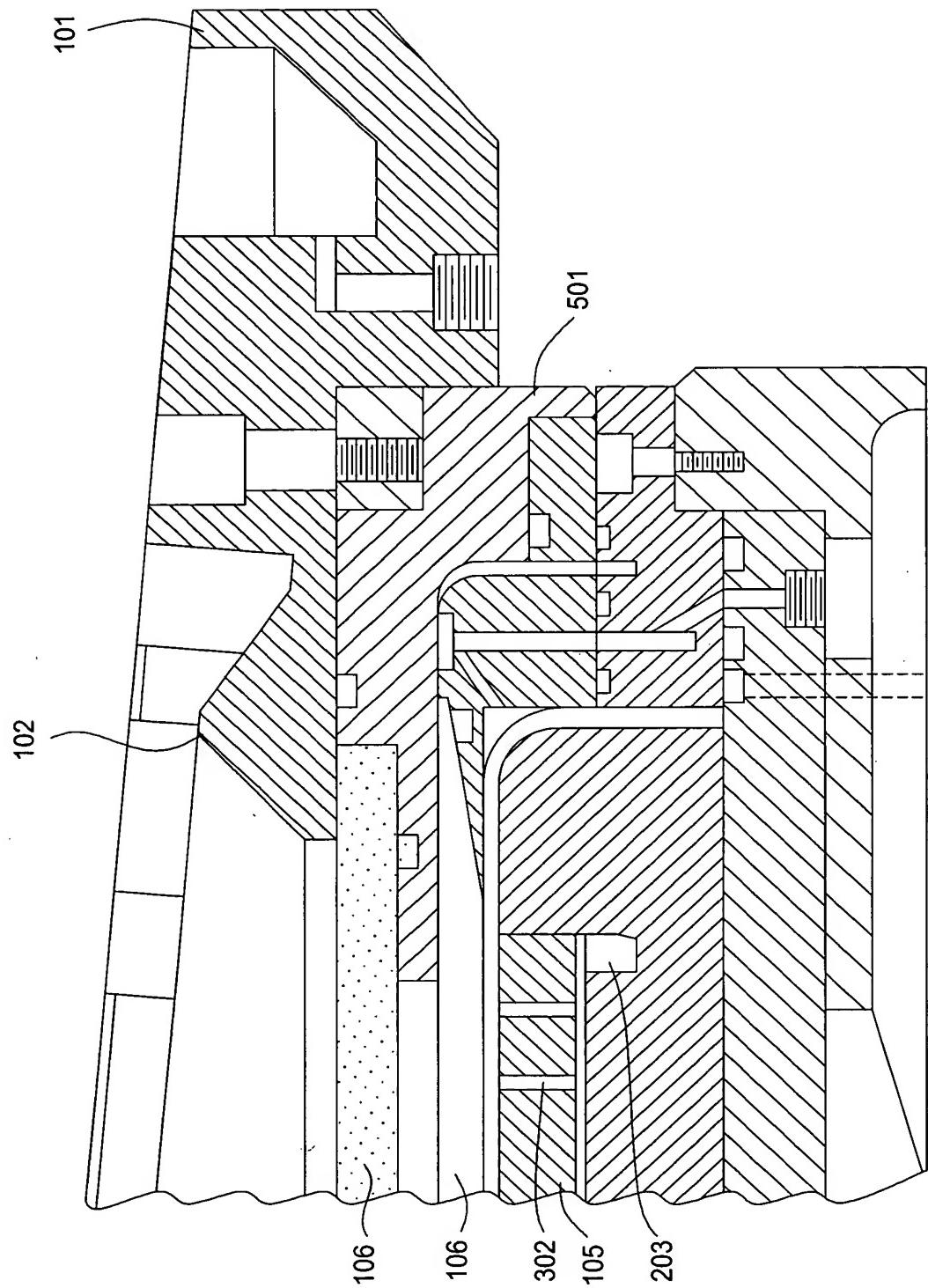


FIG. 5